

# 1.6X0.8mm SMD CHIP LED LAMP (0.25mm Height)

Part Number: KPG-1608SURKC-T Hyper Red

### **Features**

- 1.6mmX0.8mm SMT LED, 0.25mm thickness.
- Low power consumption.
- Wide viewing angle.
- Compatible with automatic placement equipment.
- Ideal for backlight and indicator.
- Package: 2000pcs / reel.
- Moisture sensitivity level : level 3.
- RoHS compliant.

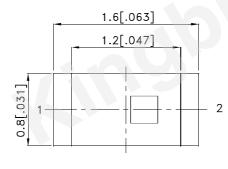
# **Description**

The Hyper Red source color devices are made with Al-GaInP on GaAs substrate Light Emitting Diode.

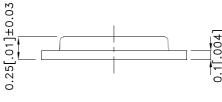
# **Applications**

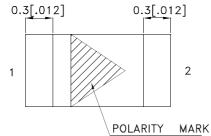
- 1. Mobile phone Keypad indicator and backlight.
- 2.Flat backlight for LCD, switch and symbol.
- 3.Toys.

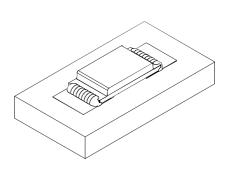
# **Package Dimensions**











- 1. All dimensions are in millimeters (inches).
- 2. Tolerance is ±0.1(0.004") unless otherwise noted.
- The specifications, characteristics and technical data described in the datasheet are subject to change without prior notice.
   The device has a single mounting surface. The device must be mounted according to the specifications.

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## **Selection Guide**

Part No.	Dice	Lens Type	lv (mcd) [2] @ 20mA		Viewing Angle [1]
		, , , , , , , , , , , , , , , , , , ,	Min.	Тур.	201/2
KDC 40000 LDKC T	Hyper Red (AlGaInP)	Water Clear	200	350	- 120°
KPG-1608SURKC-T			*55	*110	

- Notes:

  1. 01/2 is the angle from optical centerline where the luminous intensity is 1/2 of the optical peak value.

  2. Luminous intensity/ luminous Flux: +/-15%.

  \* Luminous intensity value is traceable to the CIE127-2007 compliant national standards.

## Electrical / Optical Characteristics at TA=25°C

Symbol	Parameter	Device	Тур.	Max.	Units	Test Conditions
λpeak	Peak Wavelength	Hyper Red	645		nm	IF=20mA
λD [1]	Dominant Wavelength	Hyper Red	630		nm	IF=20mA
Δλ1/2	Spectral Line Half-width	Hyper Red	20		nm	IF=20mA
С	Capacitance	Hyper Red	35		pF	VF=0V;f=1MHz
VF [2]	Forward Voltage	Hyper Red	2	2.5	V	IF=20mA
lr	Reverse Current	Hyper Red		10	uA	V <sub>R</sub> =5V

### Notes:

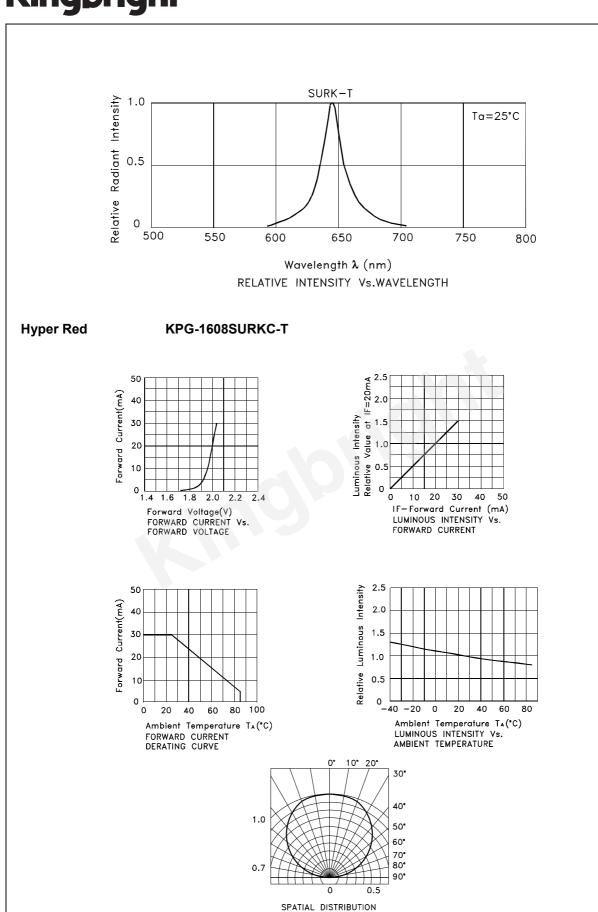
- 1.Wavelength: +/-1nm.
- 2. Forward Voltage: +/-0.1V.
- 3. Wavelength value is traceable to the CIE127-2007 compliant national standards.

# Absolute Maximum Ratings at TA=25°C

Parameter	Hyper Red	Units		
Power dissipation	75			
DC Forward Current	30	mA		
Peak Forward Current [1]	150	mA		
Reverse Voltage	5	V		
Operating Temperature	-40°C To +85°C	-40°C To +85°C		
Storage Temperature	-40°C To +85°C	-40°C To +85°C		

Note: 1. 1/10 Duty Cycle, 0.1ms Pulse Width.

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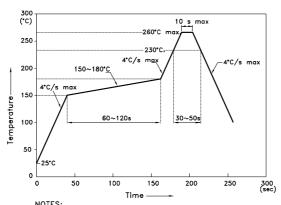
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### **KPG-1608SURKC-T**

Reflow soldering is recommended and the soldering profile is shown below. Other soldering methods are not recommended as they might cause damage to the product.

Reflow Soldering Profile For Lead-free SMT Process.



- NOTES:

  1.We recommend the reflow temperature 245°C(+/-5°C).The maximum soldering temperature should be limited to 260°C.

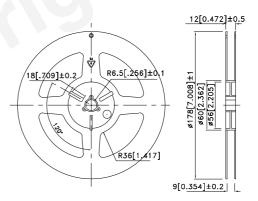
  2.Don't cause stress to the epoxy resin while it is exposed to high temperature.
- to high temperature.

  3.Number of reflow process shall be 2 times or less.

Recommended Soldering Pattern (Units: mm; Tolerance: ± 0.1)

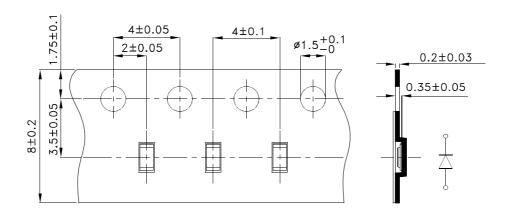


## **Reel Dimension**



Tape Dimensions (Units: mm)

TAPE

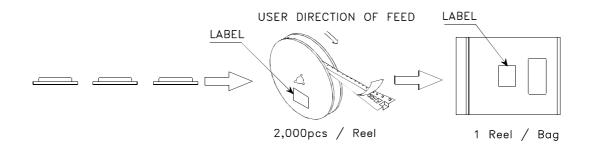


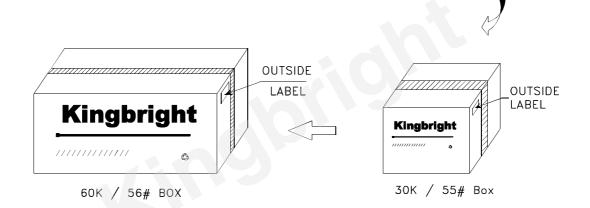
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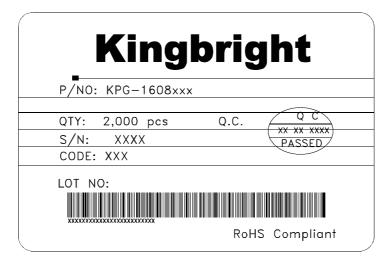
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## **PACKING & LABEL SPECIFICATIONS**

## **KPG-1608SURKC-T**







Detailed application notes are listed on our website. http://www.kingbright.com/application notes

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